THE UNITED STATES PATENT AND TRADEMARK OFFICE

REVOCATION AND NEW POWER OF ATTORNEY AND CHANGE OF CORRESPONDENCE ADDRESS

I, Dr. Graham Fisher, Director of Intellectual Property of MEMC Electronic Materials, Inc., the Assignee of the entire right, title, and interest in the U.S. Patent Application(s) and/or Patent(s) identified on the attached Schedule A, hereby revoke all previous powers of attorney or authorizations of agent given and do hereby appoint the attorneys or agents associated with the following Customer Number, with full power of substitution and revocation, to prosecute and transact all business in the Patent and Trademark Office connected therewith for the U.S. Patent Application(s) and/or Patent(s) listed in the attached Schedule A:

Customer Number: 76681

Please direct all correspondence in connection with said U.S. Patent Application(s) and/or Patent(s) to:

Customer Number: 76681

5/13/2008

Respectfully submitted,

Dr. Graham Fisher

Director of Intellectual Property MEMC Electronic Materials, Inc.

THE UNITED STATES PATENT AND TRADEMARK OFFICE

STATEMENT UNDER 37 CFR 3.73(b)

MEMC Electronic Materials, Inc., a Delaware Corporation, pursuant to 37 CFR 3.73(b), hereby states that it is the Assignee of the entire right, title, and interest in U.S. Patent Application(s) and/or Patent(s) on the attached Schedule A.

The entire rights, title, and interest in the aforementioned Patent Application(s) and/or Patent(s) were conveyed to *MEMC Electronic Materials, Inc.* via Assignment(s) recorded with the United States Patent and Trademark Office at the *Reel/Frame Numbers on the attached Schedule A.*

The undersigned, Dr. Graham Fisher, Director of Intellectual Property, has full authorization to act on behalf of Assignee MEMC Electronic Materials, Inc.

Date: 5/13/2008

Respectfully submitted,

Dr. Graham Fisher

Director of Intellectual Property MEMC Electronic Materials, Inc.

APPENDIX A Owned by MEMC Electronic Materials, Inc.

| ATTORNEY REFERENCE | CONF. NO | PUBLICATION NO. & DATE | SERIAL NO. FILING DATE | PATENT NO. ISSUE DATE | CURRENT OWNER/ ASSIGNEE | REEL AND FRAME NO. | ПП.Е |
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| MEMC2614 | 6202 | US-2002-0007779-A1 1/24/2002 | 09/475,320 12/30/1999 | 6,638,357 10/28/2003 | MEMC Electronic Materials, Inc | 010688/0082 | METHOD FOR REVEALING AGGLOMERATED INTRINSIC POINT DEFECTS IN SEMICONDUCTOR CRYSTALS |
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| MEMC2641 | 4842 | | 09/566,890 5/8/2000 | 6,444,027 9/3/2002 | MEMC Electronic Materials, Inc. | 011003/0198 | MODIFIED SUSCEPTOR FOR USE IN CHEMICAL VAPOR DEPOSITION PROCESS |
| MEMC2641.4 | 9780 | US-2003-0041799-A1 3/B/2003 | 10/229,415 8/28/2002 | 6,852,850 11/25/2003 | MEMC Electronic Materials, inc | Continuation of 09/566 890 recorded at 011003/0198 | MODIFIED SUSCEPTOR FOR USE IN CHEMICAL VAPOR DEPOSITION PROCESS |
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